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Electronic Filing System (EFS) Data  
Electronic Patent Application Submission  
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EFS ID: 64278

Application ID: 10766046



Title of Invention: LEADFRAME TYPE  
SEMICONDUCTOR PACKAGE  
HAVING REDUCED INDUCTANCE  
AND ITS MANUFACTURING  
METHOD

First Named Inventor: GI KIM

Domestic/Foreign Application: Domestic Application

Filing Date: 2004-01-28

Effective Receipt Date: 2004-07-09

Submission Type: Information Disclosure  
Statement

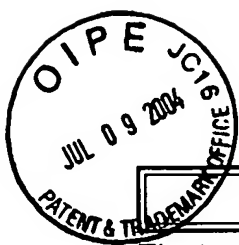
Filing Type:

Confirmation number: 2288

Attorney Docket Number: AMKOR099A

Total Fees Authorized:


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Certificate Message Digest: 3f08c81e8cfa5708a1323ac57761819a88b3145e

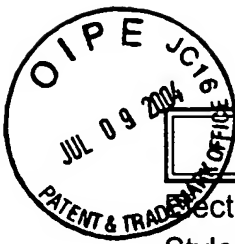


# TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0

Title of Invention	LEADFRAME TYPE SEMICONDUCTOR PACKAGE HAVING REDUCED INDUCTANCE AND ITS MANUFACTURING METHOD									
Application Number: 10/766046 										
Date: 2004-01-28										
First Named Applicant: GI JEONG KIM										
Confirmation Number: 2288										
Attorney Docket Number: AMKOR099A										
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<table border="1"><thead><tr><th>Submitted by:</th><th>Elec. Sign.</th><th>Sign. Capacity</th></tr></thead><tbody><tr><td>MARK B. GARRED Registered Number: 34,823</td><td>/mbg/</td><td>Attorney</td></tr></tbody></table>			Submitted by:	Elec. Sign.	Sign. Capacity	MARK B. GARRED Registered Number: 34,823	/mbg/	Attorney		
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MARK B. GARRED Registered Number: 34,823	/mbg/	Attorney								
<table><tr><td>Documents being submitted</td><td>Files</td></tr><tr><td>us-ids</td><td>ids4-usidst.xml</td></tr><tr><td></td><td>us-ids.dtd</td></tr><tr><td></td><td>us-ids.xsl</td></tr></table>			Documents being submitted	Files	us-ids	ids4-usidst.xml		us-ids.dtd		us-ids.xsl
Documents being submitted	Files									
us-ids	ids4-usidst.xml									
	us-ids.dtd									
	us-ids.xsl									
Comments										



# ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18  
Stylesheet Version v18.0

Title of  
Invention

LEADFRAME TYPE SEMICONDUCTOR PACKAGE  
HAVING REDUCED INDUCTANCE AND ITS  
MANUFACTURING METHOD

Application Number: 10/766046  
Confirmation Number: 2288  
First Named Applicant: GI KIM  
Attorney Docket Number: AMKOR099A  
Art Unit: 2613

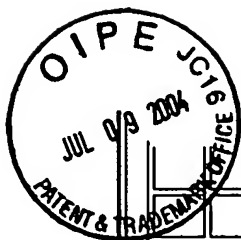


Search string: ( 5886398 or 5894108 or 5897339 or 5900676  
or 5903049 or 5903050 or 5909053 or 5915998  
or 5917242 or 5939779 or 5942794 or 5951305  
or 5959356 or 5969426 or 5973388 or 5976912  
or 5977613 or 5977615 or 5977630 or 5981314  
or 5986333 or 5986885 or 6001671 or 6013947  
or 6018189 or 6020625 or 6025640 or 6031279  
or 6034423 or RE36613 or 6040626 or 6043430  
or 6060768 or 6060769 or 6072228 or 6075284  
or 6081029 or 6084310 or 6087715 or 6087722  
or 6100594 or 6114752 or 6113474 or 6118174  
or 6118184 or 6130115 or 6130473 or RE36907  
or 6133623 or 6140154 ).pn.

## US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
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Signature

Examiner Name	Date